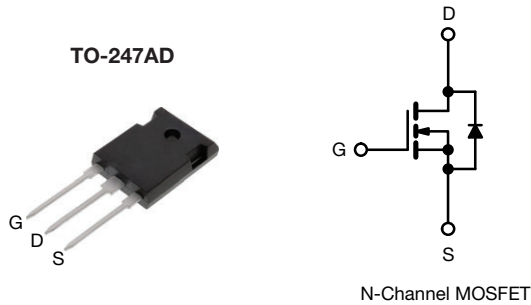


## E Series Power MOSFET



### FEATURES

- Low figure-of-merit (FOM):  $R_{on} \times Q_g$
- Low input capacitance ( $C_{iss}$ )
- Reduced switching and conduction losses
- Ultra low gate charge ( $Q_g$ )
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

| PRODUCT SUMMARY                         |                 |       |
|---|-----------------|-------|
| $V_{DS}$ (V) at $T_J$ max.              | 650             |       |
| $R_{DS(on)}$ max. ( $\Omega$ ) at 25 °C | $V_{GS} = 10$ V | 0.099 |
| $Q_g$ max. (nC)                         | 150             |       |
| $Q_{gs}$ (nC)                           | 24              |       |
| $Q_{gd}$ (nC)                           | 42              |       |
| Configuration                           | Single          |       |

| ORDERING INFORMATION            |                |
|---------------------------------|----------------|
| Package                         | TO-247AD       |
| Lead (Pb)-free and Halogen-free | SiHW33N60E-GE3 |


| ABSOLUTE MAXIMUM RATINGS ( $T_C = 25$ °C, unless otherwise noted) |                  |                                 |      |
|---|------------------|---------------------------------|------|
| PARAMETER   | SYMBOL           | LIMIT                           | UNIT |
| Drain-Source Voltage  | $V_{DS}$         | 600                             | V    |
| Gate-Source Voltage   | $V_{GS}$         | $\pm 30$                        |      |
| Continuous Drain Current ( $T_J = 150$ °C)                        | $V_{GS}$ at 10 V | $T_C = 25$ °C                   | 33   |
|   |                  | $T_C = 100$ °C                  | 21   |
| Pulsed Drain Current <sup>a</sup>                                 | $I_{DM}$         | 88                              | A    |
| Linear Derating Factor  |                  | 2.2                             | W/°C |
| Single Pulse Avalanche Energy <sup>b</sup>                        | $E_{AS}$         | 793                             | mJ   |
| Maximum Power Dissipation   | $P_D$            | 278                             | W    |
| Operating Junction and Storage Temperature Range                  | $T_J, T_{stg}$   | -55 to +150                     | °C   |
| Drain-Source Voltage Slope  | $dV/dt$          | $V_{DS} = 0$ V to 80 % $V_{DS}$ | 70   |
| Reverse Diode $dV/dt$ <sup>d</sup>                                |                  | 12                              |      |
| Soldering Recommendations (Peak temperature) <sup>c</sup>         | for 10 s         | 300                             | °C   |

#### Notes

- Repetitive rating; pulse width limited by maximum junction temperature.
- $V_{DD} = 50$  V, starting  $T_J = 25$  °C,  $L = 28.2$  mH,  $R_g = 25$   $\Omega$ ,  $I_{AS} = 7.5$  A.
- 1.6 mm from case.
- $I_{SD} \leq I_D$ ,  $dI/dt = 100$  A/ $\mu$ s, starting  $T_J = 25$  °C.



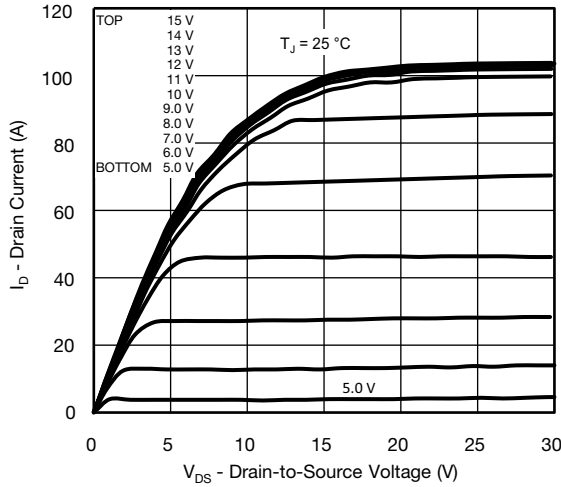
| THERMAL RESISTANCE RATINGS       |            |      |      |      |
|----------------------------------|------------|------|------|------|
| PARAMETER                        | SYMBOL     | TYP. | MAX. | UNIT |
| Maximum Junction-to-Ambient      | $R_{thJA}$ | -    | 40   | °C/W |
| Maximum Junction-to-Case (Drain) | $R_{thJC}$ | -    | 0.45 |      |

| SPECIFICATIONS ( $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise noted) |                     |   |  |      |       |           |               |
|---|---------------------|---|--|------|-------|-----------|---------------|
| PARAMETER   | SYMBOL              | TEST CONDITIONS   |  | MIN. | TYP.  | MAX.      | UNIT          |
| <b>Static</b>   |                     |   |  |      |       |           |               |
| Drain-Source Breakdown Voltage  | $V_{DS}$            | $V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$   |  | 600  | -     | -         | V             |
| $V_{DS}$ Temperature Coefficient  | $\Delta V_{DS}/T_J$ | Reference to $25\text{ }^\circ\text{C}, I_D = 1\text{ mA}$  |  | -    | 0.71  | -         | V/°C          |
| Gate-Source Threshold Voltage (N)   | $V_{GS(th)}$        | $V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$   |  | 2.0  | -     | 4.0       | V             |
| Gate-Source Leakage   | $I_{GSS}$           | $V_{GS} = \pm 20\text{ V}$  |  | -    | -     | $\pm 100$ | nA            |
|   |                     | $V_{GS} = \pm 30\text{ V}$  |  | -    | -     | $\pm 1$   | $\mu\text{A}$ |
| Zero Gate Voltage Drain Current   | $I_{DSS}$           | $V_{DS} = 600\text{ V}, V_{GS} = 0\text{ V}$  |  | -    | -     | 1         | $\mu\text{A}$ |
|   |                     | $V_{DS} = 480\text{ V}, V_{GS} = 0\text{ V}, T_J = 125\text{ }^\circ\text{C}$   |  | -    | -     | 10        |               |
| Drain-Source On-State Resistance  | $R_{DS(on)}$        | $V_{GS} = 10\text{ V}$  | $I_D = 16.5\text{ A}$                        | -    | 0.083 | 0.099     | $\Omega$      |
| Forward Transconductance <sup>a</sup>                                       | $g_{fs}$            | $V_{DS} = 30\text{ V}, I_D = 16.5\text{ A}$   |  | -    | 11    | -         | S             |
| <b>Dynamic</b>  |                     |   |  |      |       |           |               |
| Input Capacitance   | $C_{iss}$           | $V_{GS} = 0\text{ V},$<br>$V_{DS} = 100\text{ V},$<br>$f = 1\text{ MHz}$  |  | -    | 3508  | -         | pF            |
| Output Capacitance  | $C_{oss}$           |   |  | -    | 156   | -         |               |
| Reverse Transfer Capacitance  | $C_{rss}$           |   |  | -    | 6     | -         |               |
| Effective Output Capacitance, Energy Related <sup>b</sup>                   | $C_{o(er)}$         | $V_{GS} = 0\text{ V}, V_{DS} = 0\text{ V to } 480\text{ V}$   |  | -    | 136   | -         |               |
| Effective Output Capacitance, Time Related <sup>c</sup>                     | $C_{o(tr)}$         |   |  | -    | 468   | -         |               |
| Total Gate Charge   | $Q_g$               | $V_{GS} = 10\text{ V}$  | $I_D = 16.5\text{ A}, V_{DS} = 480\text{ V}$ | -    | 100   | 150       | nC            |
| Gate-Source Charge  | $Q_{gs}$            |   |  | -    | 24    | -         |               |
| Gate-Drain Charge   | $Q_{gd}$            |   |  | -    | 42    | -         |               |
| Turn-On Delay Time  | $t_{d(on)}$         | $V_{DD} = 480\text{ V}, I_D = 16.5\text{ A}$<br>$R_g = 9.1\text{ }\Omega, V_{GS} = 10\text{ V}$   |  | -    | 28    | 56        | ns            |
| Rise Time   | $t_r$               |   |  | -    | 60    | 90        |               |
| Turn-Off Delay Time   | $t_{d(off)}$        |   |  | -    | 99    | 150       |               |
| Fall Time   | $t_f$               |   |  | -    | 54    | 80        |               |
| Gate Input Resistance   | $R_g$               | $f = 1\text{ MHz}, \text{open drain}$   |  | 0.2  | 0.7   | 1.0       | $\Omega$      |
| <b>Drain-Source Body Diode Characteristics</b>                              |                     |   |  |      |       |           |               |
| Continuous Source-Drain Diode Current                                       | $I_S$               | MOSFET symbol showing the integral reverse p - n junction diode  |  | -    | -     | 33        | A             |
| Pulsed Diode Forward Current  | $I_{SM}$            |   |  | -    | -     | 88        |               |
| Diode Forward Voltage   | $V_{SD}$            | $T_J = 25\text{ }^\circ\text{C}, I_S = 16.5\text{ A}, V_{GS} = 0\text{ V}$  |  | -    | 0.9   | 1.2       | V             |
| Reverse Recovery Time   | $t_{rr}$            | $T_J = 25\text{ }^\circ\text{C}, I_F = I_S,$<br>$di/dt = 100\text{ A}/\mu\text{s}, V_R = 20\text{ V}$   |  | -    | 503   | 1006      | ns            |
| Reverse Recovery Charge   | $Q_{rr}$            |   |  | -    | 8.5   | 17        | $\mu\text{C}$ |
| Reverse Recovery Current  | $I_{RRM}$           |   |  | -    | 26    | -         | A             |

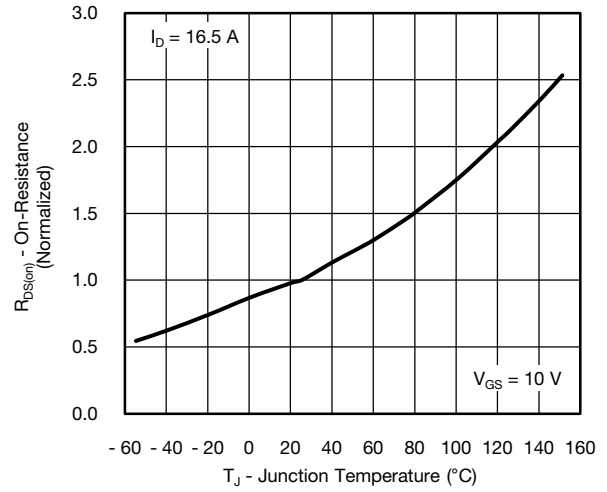
**Notes**

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .
- c.  $C_{oss(tr)}$  is a fixed capacitance that gives the charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

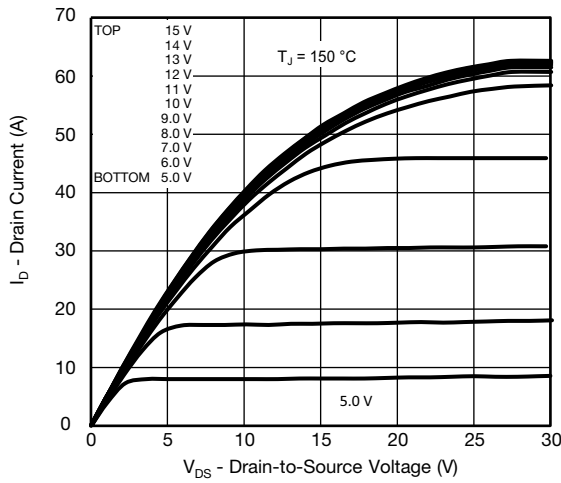
**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)



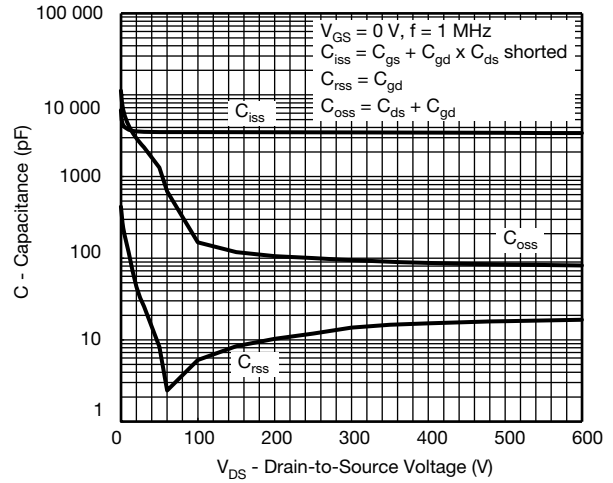
**Fig. 1 - Typical Output Characteristics**



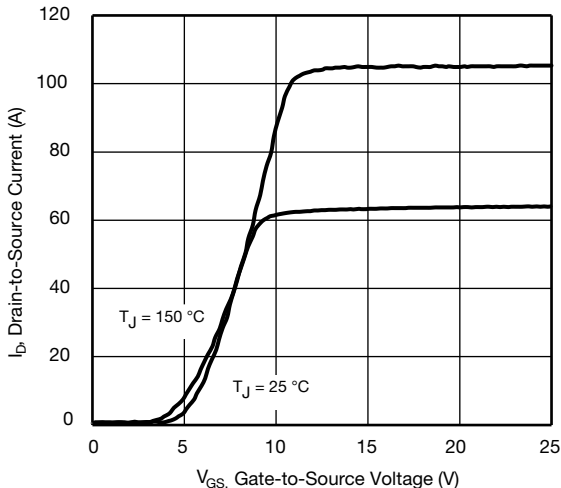
**Fig. 4 - Normalized On-Resistance vs. Temperature**



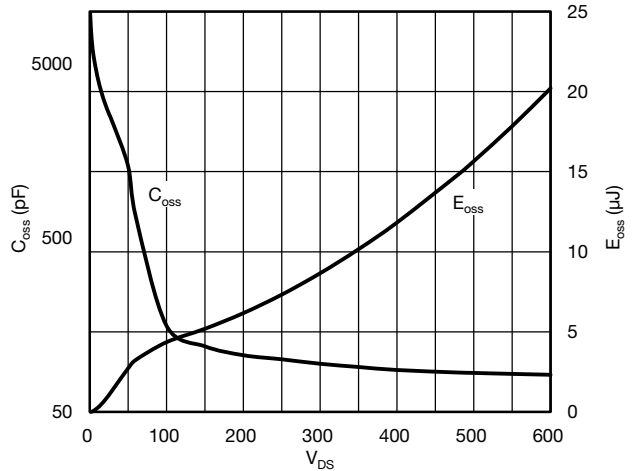
**Fig. 2 - Typical Output Characteristics**



**Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage**



**Fig. 3 - Typical Transfer Characteristics**



**Fig. 6 - Coss and Eoss vs. Vds**

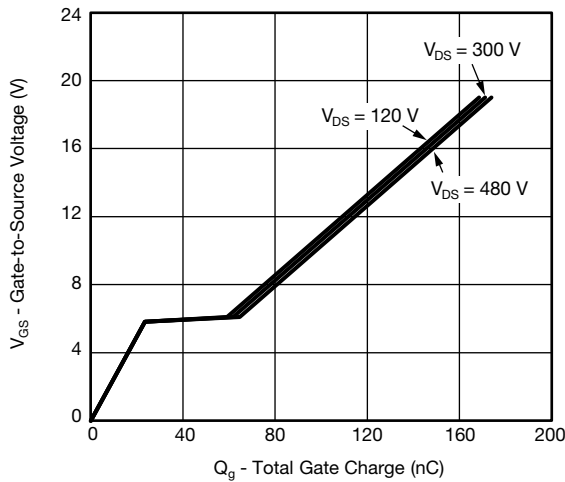


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

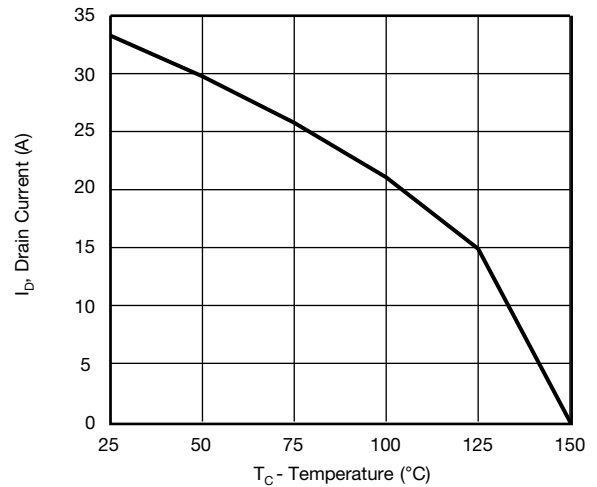


Fig. 10 - Maximum Drain Current vs. Case Temperature

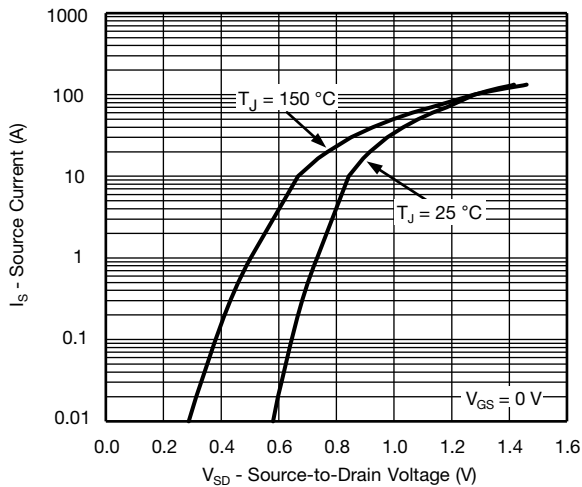


Fig. 8 - Typical Source-Drain Diode Forward Voltage

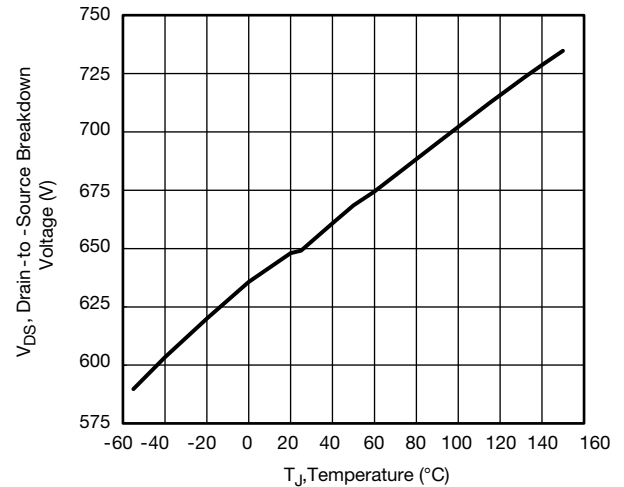


Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature

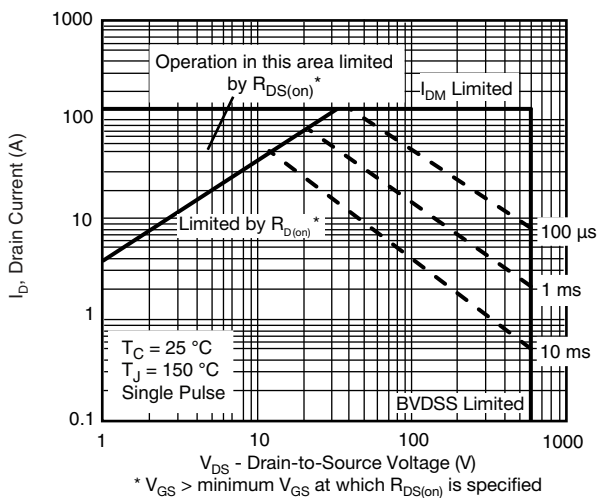


Fig. 9 - Maximum Safe Operating Area

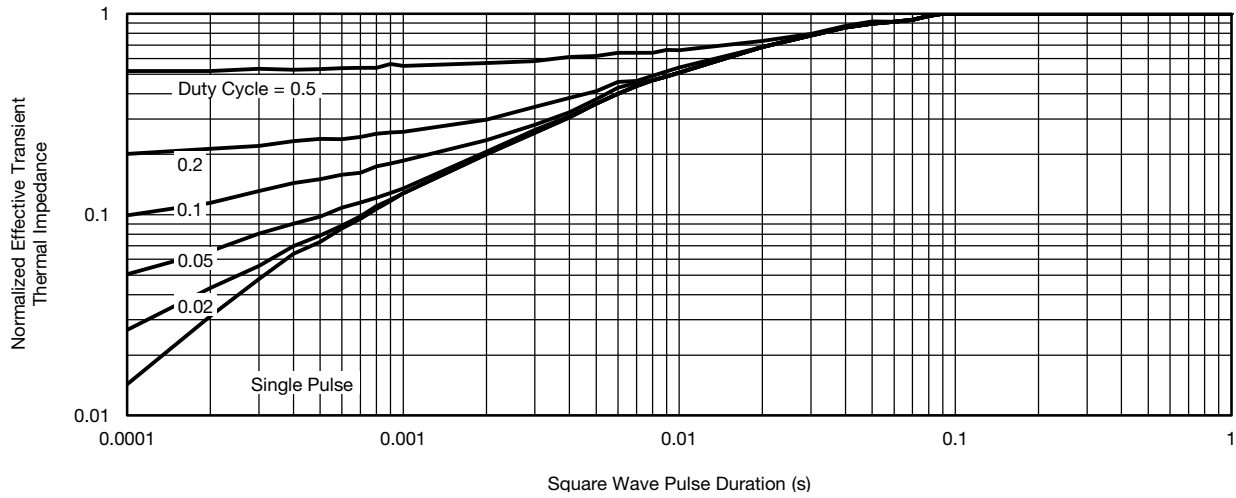


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

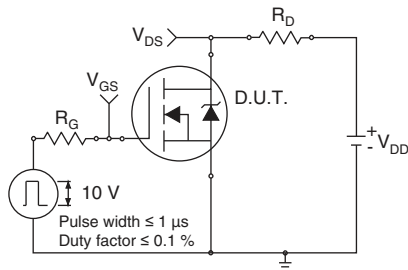


Fig. 13 - Switching Time Test Circuit

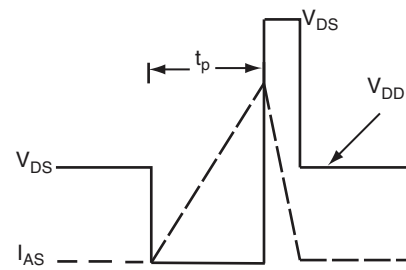


Fig. 16 - Unclamped Inductive Waveforms

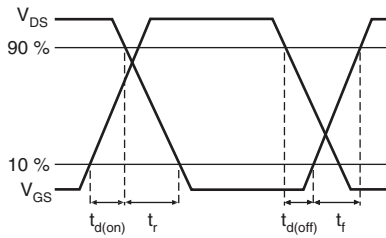


Fig. 14 - Switching Time Waveforms

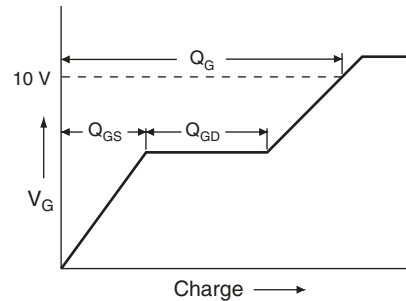


Fig. 17 - Basic Gate Charge Waveform

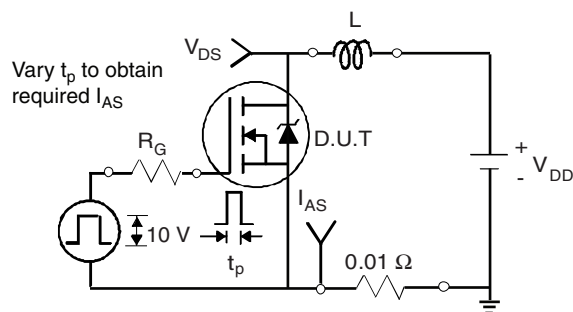


Fig. 15 - Unclamped Inductive Test Circuit

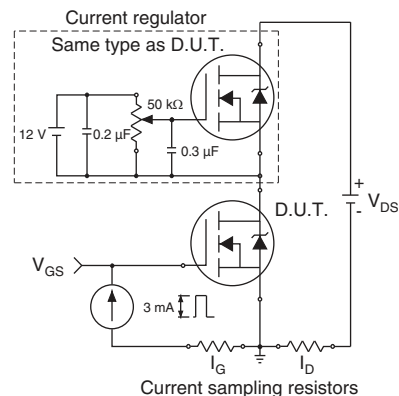
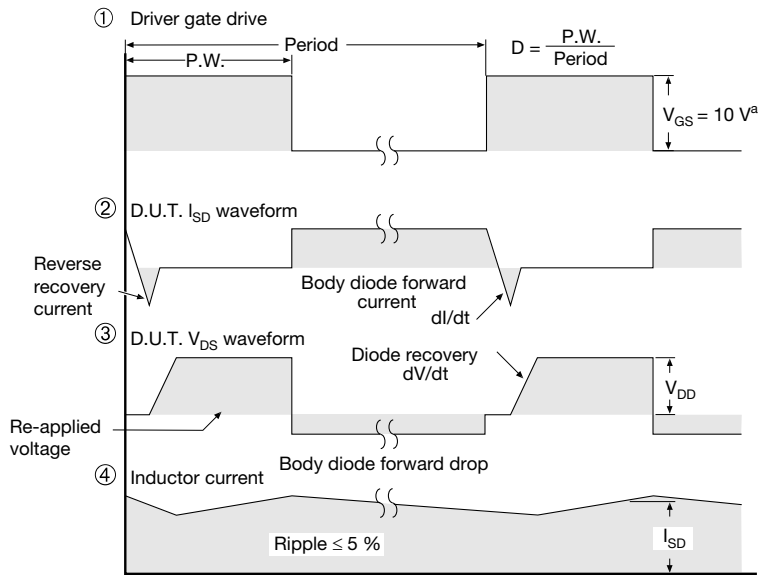
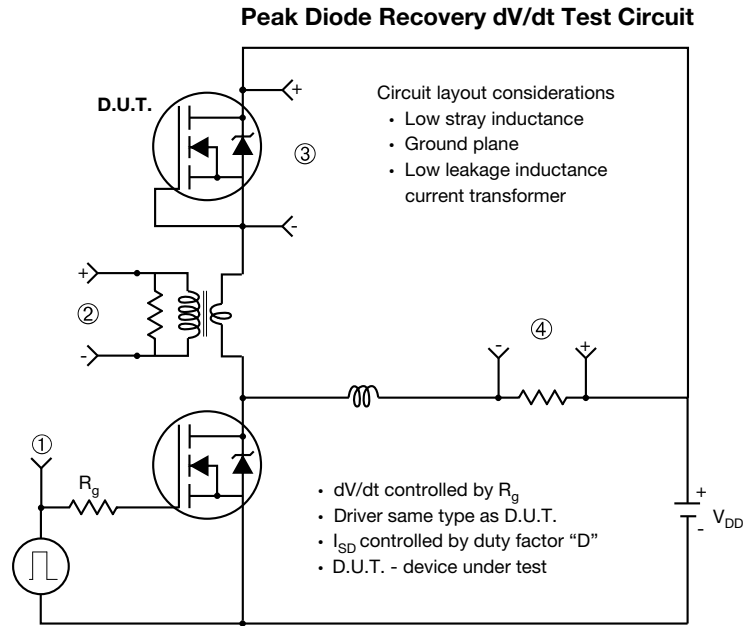


Fig. 18 - Gate Charge Test Circuit



**Note**

a.  $V_{GS} = 5 V$  for logic level devices

**Fig. 19 - For N-Channel**

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## TO-247AD (High Voltage)



| DIM.                            | MILLIMETERS |       | INCHES    |       |
|---------------------------------|-------------|-------|-----------|-------|
|                                 | MIN.        | MAX.  | MIN.      | MAX.  |
| A                               | 4.70        | 5.31  | 0.185     | 0.209 |
| A1                              | 2.21        | 2.59  | 0.087     | 0.102 |
| A2                              | 1.50        | 2.49  | 0.059     | 0.098 |
| b                               | 0.99        | 1.40  | 0.039     | 0.055 |
| b2                              | 1.65        | 2.41  | 0.065     | 0.095 |
| b4                              | 2.59        | 3.43  | 0.102     | 0.135 |
| c                               | 0.61 BSC    |       | 0.024 BSC |       |
| D                               | 20.80       | 21.46 | 0.819     | 0.845 |
| D1                              | 3.68        | 5.49  | 0.145     | 0.216 |
| (e)                             | 5.46 BSC    |       | 0.215 BSC |       |
| E                               | 15.49       | 16.26 | 0.610     | 0.640 |
| L                               | 19.81       | 20.32 | 0.780     | 0.800 |
| L1                              | 4.06        | 4.50  | 0.160     | 0.177 |
| $\varnothing p$                 | 3.51        | 3.66  | 0.138     | 0.144 |
| ECN: S17-0178-Rev. B, 06-Feb-17 |             |       |           |       |
| DWG: 6010                       |             |       |           |       |



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